REQUEST FOR PROPOSAL (RFP)

<u>SUPPORITING MONITORING & MEASURING, REVIEWING AND VERIFICATION (MRV)</u> <u>DEVELOPMENT OF THE REED+ IMPLEMENTATION</u>

Process No: 4792

CLARIIFICATION TO BIDDER'S QUERIES 3

Reference to the above RFP, UNDP has received the below queries from bidder and we would like to share the clarification as below:

RFP Items	Question/Clarification	Answer/Remarks
Section 5: Documents Establishing the in the Eligible and qualification of the Proposer	Shall "Proposer Information Form" be enclosed in an envelope for Technical Proposal?	Yes. The technical proposal envelop contains the following documents: - Proposal Submission Form (see RFP Section 4); - Documents Establishing the Eligibility and Qualifications of the Proposer (see RFP Section 5); - Technical Proposal (see prescribed form in RFP Section 6); - Any attachments and/or appendices to the Proposal
Section2: Introduction to proposers- Section C	2. Shall "Proposal Submission Form" also be enclosed in an envelope for Technical Proposal?	See the above answer.
Section 6: Technical Proposal Form	Article 2.9 Statement of Full Disclose of Section 2 of Technical Proposal Format says "This is intended to disclose any potential conflict in accordance with the definition of "conflict" under Section 4 of this document, if any	This article is required bidders to disclose any potential conflict of interest in the following circumstances: (1) you employ or anticipant employing, (2) with any person who is or was recently employed by the UN or UNDP.
Section 6: Technical Proposal Form	Technical Proposal Form does not have Section 4 and Section 4 of RFP is Proposal Submission Form. We would appreciate it if you would show us an example of statement bidder should make.	As explained in query No 3, the statement should be made based on actual circumstance related to potential conflict of interest.